

MULTIPLE CONFIGURATION PCB HEADERS & **RECEPTACLES**





✓ Active

PRODUCT DRAWING



↓ 3D PDF

TE CONNECTIVITY (TE)

3P AMPMODU II STIFT LEI

AMPMODU | AMPMODU Headers

826631-3

TE Internal Number: 826631-3

Always EU RoHS/ELV Compliant

Applies To Printed Circuit Board

Connector Style Plug

Centerline 2.54 mm [.1 in]

Number of Positions 3

Header Type Breakaway

AMPMODU II STIFTLEISTE 90DEG EINREIHIG **Product Drawings**

PDF **English**

CAD Files 3D PDF

PDF **3D**

Customer View Model

2D_DXF.ZIP English

Customer View Model

3D_IGS.ZIP English

Customer View Model

3D_STP.ZIP English

Product Environmental Compliance

TE Material Declaration MD_826631-3_01092015843_dmtec

PDF English

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features Applies To **Printed Circuit Board**

> Plug Connector Style

PCB Mounting Orientation **Right Angle**

Header Connector Type

	Row-to-Row Spacing	2.54 mm [.1 in]
	Stabilizers	Without
	Strain Relief	Without
	Board Standoff	Without
	Profile	Standard
	Product Type	Connector
	Gasket	Without
Configuration Features	Number of Positions	3
	Number of Rows	1
	Keyed	No
	Selectively Loaded	No
Body Features	Header Type	Breakaway
	Post Size (mm)	.63
Contact Features	Contact Protection	Without
Contact reatures		
	Contact Type Contact Base Material	Phoenhou Proper
	Contact base iviaterial	Phosphor Bronze
	Control Mating Anna Disting This language (via)	20
	Contact Mating Area Plating Thickness (µin)	30
	Solder Tail Contact Plating Material	Tin
Termination Features	Solder Tail Contact Plating Material	Tin
Termination Features	Solder Tail Contact Plating Material Contact Mating Area Plating Material	Tin Gold
Termination Features	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length	Tin Gold 3.2 mm [.1259 in]
Termination Features	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material	Tin Gold 3.2 mm [.1259 in] Tin Over Nickel
Termination Features	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm)	Tin Gold 3.2 mm [.1259 in] Tin Over Nickel
Termination Features Mechanical Attachment	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm)	Tin Gold 3.2 mm [.1259 in] Tin Over Nickel
	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm) Termination Method to PC Board	Tin Gold 3.2 mm [.1259 in] Tin Over Nickel 3 Through Hole
	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm) Termination Method to PC Board PCB Mount Retention	Tin Gold 3.2 mm[.1259 in] Tin Over Nickel 3 Through Hole Without
	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm) Termination Method to PC Board PCB Mount Retention Panel Mount Retention	Tin Gold 3.2 mm[.1259 in] Tin Over Nickel 3 Through Hole Without Without
	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm) Termination Method to PC Board PCB Mount Retention Panel Mount Retention Mating Alignment	Tin Gold 3.2 mm [.1259 in] Tin Over Nickel 3 Through Hole Without Without Without
	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm) Termination Method to PC Board PCB Mount Retention Panel Mount Retention Mating Alignment	Tin Gold 3.2 mm [.1259 in] Tin Over Nickel 3 Through Hole Without Without Without
Mechanical Attachment	Solder Tail Contact Plating Material Contact Mating Area Plating Material Termination Post Length Termination End Plating Material Termination End Plating Thickness (µm) Termination Method to PC Board PCB Mount Retention Panel Mount Retention Mating Alignment Mating Connector Lock	Tin Gold 3.2 mm [.1259 in] Tin Over Nickel 3 Through Hole Without Without Without Without

Dimensions	PCB Thickness (Recommended) (in) Mating Post Length	.062 6.7 mm [.264 in]
Usage Conditions	High Temperature Housing	No
Operation/Application	High Speed Serial Data Connector	No
Industry Standards	UL Flammability Rating Approved Standards	UL 94V-0 CSA LR7189, CUL E28476
Packaging Features	Packaging Quantity Packaging Method	1500 Box
Product Compliance	Statement of Compliance	

VIEW ALL PRODUCT COMPLIANCE

CUSTOMERS ALSO BOUGHT

